

LIST OF REFERENCES CITED BY APPLICANT  
(Use several sheets if necessary)ATTY DOCKET NO.  
11478-014-999APPLICATION NO.  
10/749,339APPLICANT  
Augsburger et al.FILING DATE  
December 31, 2003GROUP  
1618

## U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	A01	5,223,264	06/29/1993	Wehling et al.			
	A02	5,639,475	06/17/1997	Bettman et al.			
	A03	5,807,577	09/15/1998	Ouali			
	A04	6,221,392	04/24/2001	Khankari et al.			
	A05	6,340,476	01/22/2002	Midha et al.			

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION
	B01	EP 0 196 546	01/29/92	EPO			YES NO

## OTHER REFERENCES (Including Author, Date, Title, Volume, Pertinent Pages, etc.)

C01	Aulton et al., 1994, "The strength and compaction of millispheres: The design of a controlled-release drug delivery system for ibuprofen in the form of a tablet comprising compacted polymer-coated millispheres," Drug Dev. and Indust. Pharm., 20(20):3069-3104.
C02	Mount et al., 1996, "Formulation and compaction of nonfracturing deformable coated beads," Drug Dev. and Indust. Pharm., 22(7):609-621.
C03	O'Connor et al., 2000, "Powders," in <u>Remington: The Science and Practice of Pharmacy</u> (Gennaro A.R., 20 <sup>th</sup> ed.), ch. 37, pp. 681-685.
C04	Rudnic et al., 2000, "Oral solid dosage forms," in <u>Remington: The Science and Practice of Pharmacy</u> (Gennaro A.R., 20 <sup>th</sup> ed.), ch. 45, pp. 858-902.
C05	Sprowls, Jr., 1960, "Wafers, cachets, konseals," in <u>American Pharmacy</u> , pp. 425-426.
C06	International Search Report, of International Application PCT/US03/41765, dated May 7, 2004
C07	International Preliminary Examination Report, of International Application PCT/US03/41765, dated October 1, 2004.

EXAMINER /Eric Silverman/ (10/06/2008)

DATE CONSIDERED

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.